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TRENCHSTOP™ Series

Green

Low Loss DuoPack : IGBT in TRENCHSTOP[™] and Fieldstop technology with soft, fast recovery anti-parallel Emitter Controlled HE diode





Features:

- Very low V_{CE(sat)} 1.5V (typ.)
- Maximum Junction Temperature 175°C
- Short circuit withstand time 5µs
- Designed for :

- Variable Speed Drive for washing machines, air conditioners and induction cooking

- Uninterrupted Power Supply

- TRENCHSTOP[™] and Fieldstop technology for 600V applications offers :
- very tight parameter distribution
- high ruggedness, temperature stable behavior
- NPT technology offers easy parallel switching capability due to positive temperature coefficient in V
- positive temperature coefficient in V_{CE(sat)}
- Low EMI
- Low Gate Charge
- Very soft, fast recovery anti-parallel Emitter Controlled HE diode
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <u>http://www.infineon.com/igbt/</u>

Туре	V _{CE}	<i>I</i> c	V _{CE(sat), Tj=25℃}	T _{j,max}	Marking Code	Package
IKP10N60T	600V	10A	1.5V	175°C	K10T60	PG-TO-220-3

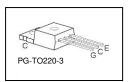
Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_j \ge 25^{\circ}C$	V _{CE}	600	V
DC collector current, limited by T_{jmax} $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$	I _C	24 18	
Pulsed collector current, t_p limited by T_{jmax}	<i>I</i> _{Cpuls}	30	
Turn off safe operating area, $V_{CE} = 600V$, $T_j = 175^{\circ}C$, $t_p = 1 \mu s$	-	30	— A
Diode forward current, limited by T_{jmax} $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$	I _F	24 18	
Diode pulsed current, t_p limited by T_{jmax}	I _{Fpuls}	30	
Gate-emitter voltage	V _{GE}	±20	V
Short circuit withstand time ²⁾ $V_{GE} = 15V, V_{CC} \le 400V, T_j \le 150^{\circ}C$	tsc	5	μs
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$	P _{tot}	110	W
Operating junction temperature	Tj	-40+175	
Storage temperature	T_{stg}	-55+150	∘C
Soldering temperature, wavesoldering, 1.6 mm (0.063 in.) from case for 10s		260	

¹J-STD-020 and JESD-022

²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.







TRENCHSTOP[™] Series

Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic		1		
IGBT thermal resistance,	$R_{ m thJC}$		1.35	K/W
junction – case				
Diode thermal resistance,	R _{thJCD}		1.9	
junction – case				
Thermal resistance,	R _{thJA}		62	
junction – ambient				

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

Devemeter	Symbol	Conditions		Unit		
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_{C}=0.2mA$	600	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{\rm GE} = 15 V, I_{\rm C} = 10 A$				
		T _j =25°C	-	1.5	2.05	
		$T_{\rm j} = 175^{\circ}{\rm C}$	-	1.8	-	
Diode forward voltage	V _F	$V_{\rm GE} = 0V, I_{\rm F} = 10A$				
		<i>T</i> _j =25°C	-	1.6	2.0	
		<i>T</i> _j =175°C	-	1.6	-	
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C}=0.3{\rm mA}, V_{\rm CE}=V_{\rm GE}$	4.1	4.6	5.7	
Zero gate voltage collector current	I _{CES}	V _{CE} =600V, V _{GE} =0V				μA
		T _j =25°C	-	-	40	
		<i>T</i> _j =175°C	-	-	1000	
Gate-emitter leakage current	I _{GES}	$V_{\rm CE} = 0 \rm V, V_{\rm GE} = 20 \rm V$	-	-	100	nA
Transconductance	$g_{ m fs}$	$V_{\rm CE} = 20 \text{V}, \ I_{\rm C} = 10 \text{A}$	-	6	-	S
Integrated gate resistor	R _{Gint}			none		Ω

Dynamic Characteristic

Input capacitance	Ciss	$V_{\rm CE}=25V$,	-	551	-	pF
Output capacitance	Coss	$V_{\rm GE}=0V$,	-	40	-	
Reverse transfer capacitance	Crss	<i>f</i> =1MHz	-	17	-	
Gate charge	Q _{Gate}	$V_{\rm CC} = 480 \text{V}, \ I_{\rm C} = 10 \text{A}$	-	62	-	nC
		$V_{\rm GE} = 15 \rm V$				
Internal emitter inductance	LE		-	7	-	nH
measured 5mm (0.197 in.) from case						
Short circuit collector current ¹⁾	I _{C(SC)}	$V_{GE} = 15V, t_{SC} \le 5\mu s$ $V_{CC} = 400V,$ $T_j = 25^{\circ}C$	-	100	-	A

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



TRENCHSTOP™ Series

Switching Characteristic, Inductive Load, at $T_i=25 \text{ °C}$

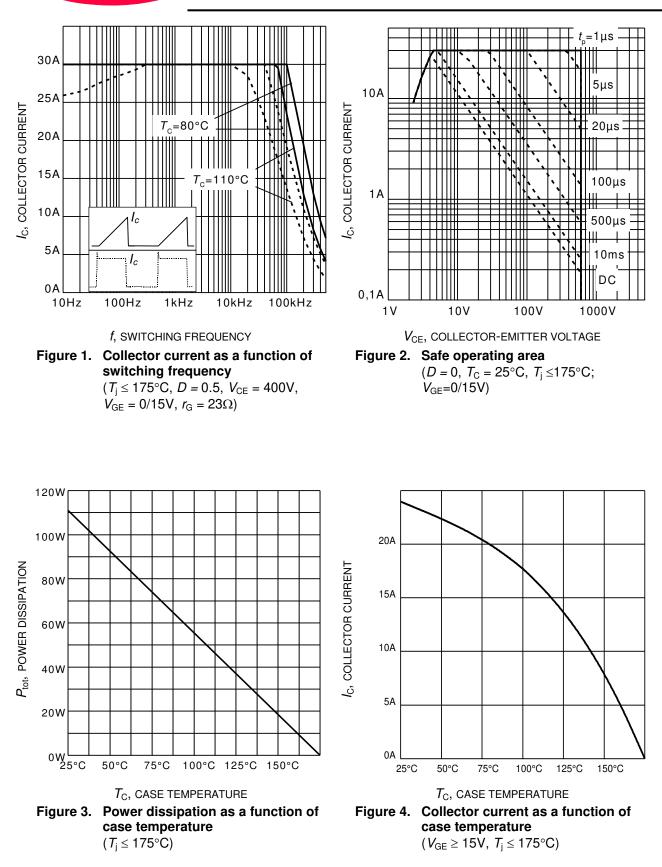
Parameter	Symbol	Conditions	Value			l lmit
Parameter			min.	typ.	max.	- Unit
IGBT Characteristic		·				•
Turn-on delay time	t _{d(on)}	$T_{j}=25^{\circ}C,$ $V_{CC}=400V, I_{C}=10A,$ $V_{GE}=0/15V, r_{G}=23\Omega,$ $L_{\sigma}=60nH, C_{\sigma}=40pF$	-	12	-	ns
Rise time	t _r		-	8	-	
Turn-off delay time	t _{d(off)}		-	215	-	
Fall time	t _f		-	38	-	
Turn-on energy	Eon	L_{σ}, C_{σ} from Fig. E Energy losses include "tail" and diode reverse recovery.	-	0.16	-	mJ
Turn-off energy	Eoff		-	0.27	-	
Total switching energy	Ets		-	0.43	-	
Anti-Parallel Diode Characteristic						
Diode reverse recovery time	t _{rr}	<i>T</i> _j =25°C,	-	115	-	ns
Diode reverse recovery charge	Q _{rr}	$V_{\rm R}$ =400V, $I_{\rm F}$ =10A,	-	0.38	-	μC
Diode peak reverse recovery current	<i>I</i> _{rrm}	di _F /dt=880A/µs	-	10	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di _{rr} /dt		-	680	-	A/μs

Switching Characteristic, Inductive Load, at T_j=175 °C

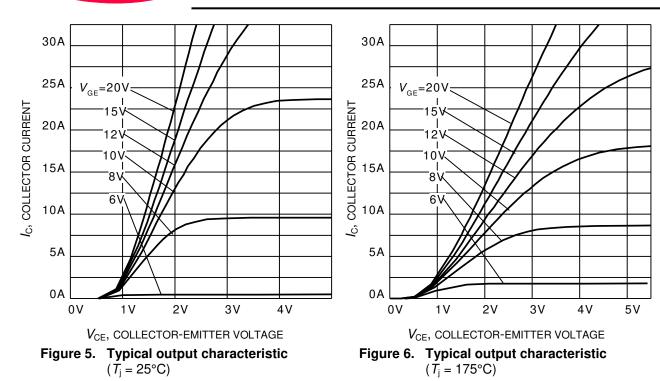
Deveratev	Symbol	Conditions	Value			1.1
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
IGBT Characteristic						•
Turn-on delay time	t _{d(on)}	$T_{j}=175 \circ C,$ $V_{CC}=400 V, I_{C}=10 A,$ $V_{GE}=0/15 V, r_{G}=23 \Omega,$ $L_{\sigma}=60 n H, C_{\sigma}=40 p F$ $L_{\sigma}, C_{\sigma} \text{ from Fig. E}$ Energy losses include "tail" and diode reverse recovery.	-	10	-	ns
Rise time	t _r		-	11	-	
Turn-off delay time	t _{d(off)}		-	233	-	
Fall time	t _f		-	63	-	
Turn-on energy	Eon		-	0.26	-	mJ
Turn-off energy	E _{off}		-	0.35	-	
Total switching energy	Ets		-	0.61	-	
Anti-Parallel Diode Characteristic						•
Diode reverse recovery time	t _{rr}	<i>T</i> _j =175°C	-	200	-	ns
Diode reverse recovery charge	Q _{rr}	$V_{\rm R}$ =400V, $I_{\rm F}$ =10A,	-	0.92	-	μC
Diode peak reverse recovery current	<i>I</i> _{rrm}	di _F /dt=880A/µs	-	13	-	А
Diode peak rate of fall of reverse recovery current during <i>t</i> _b	di _{rr} /dt	1	-	390	-	A/µs

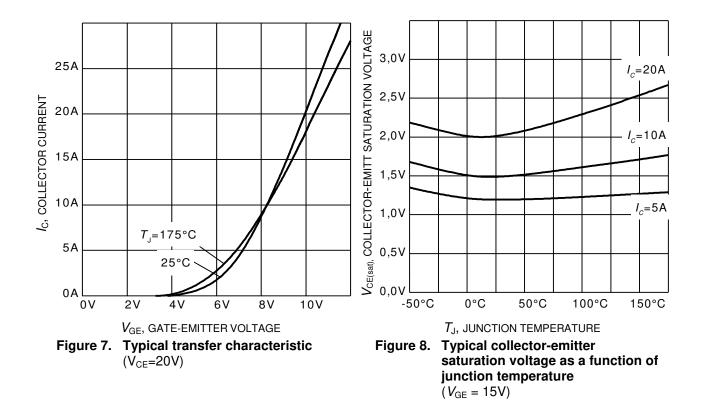


TRENCHSTOP[™] Series

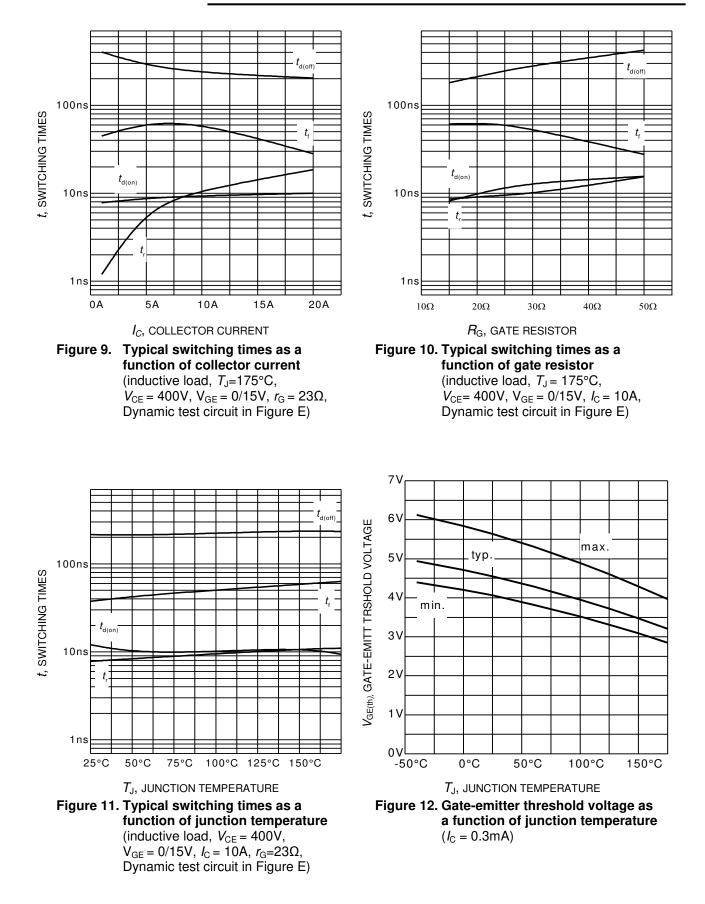




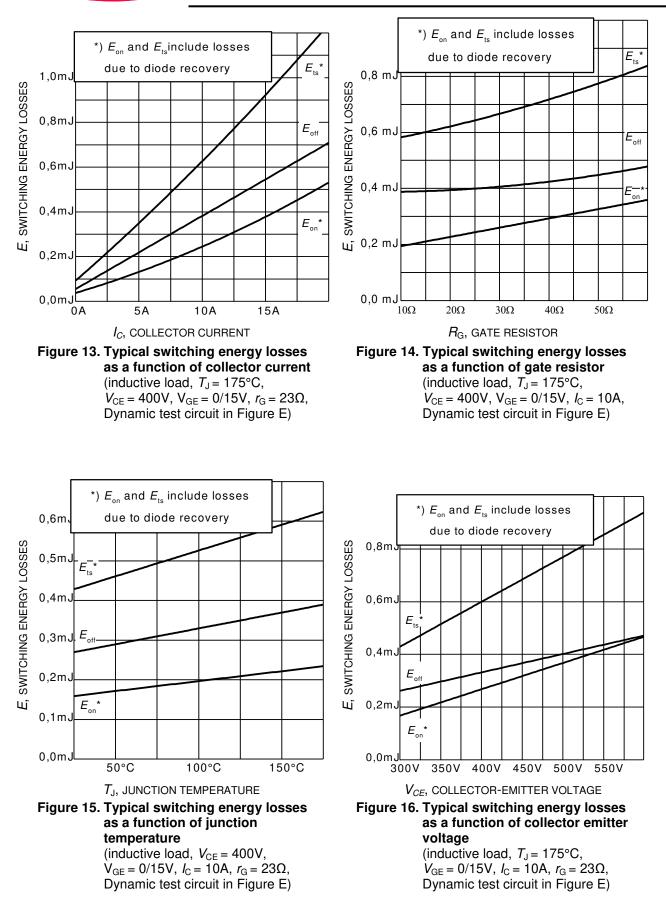




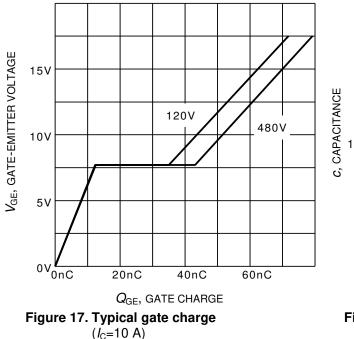


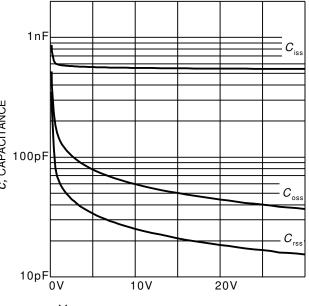




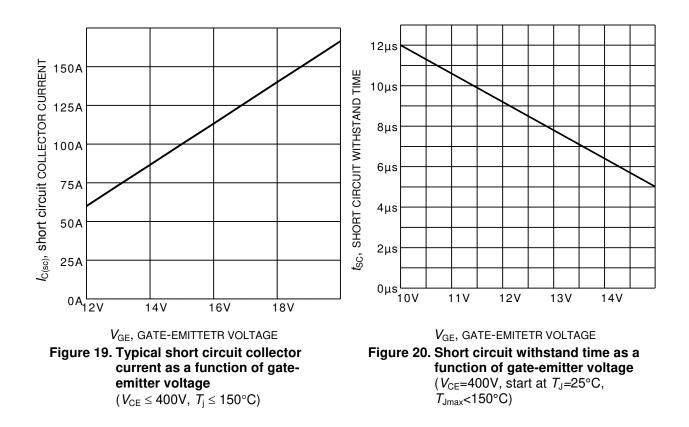




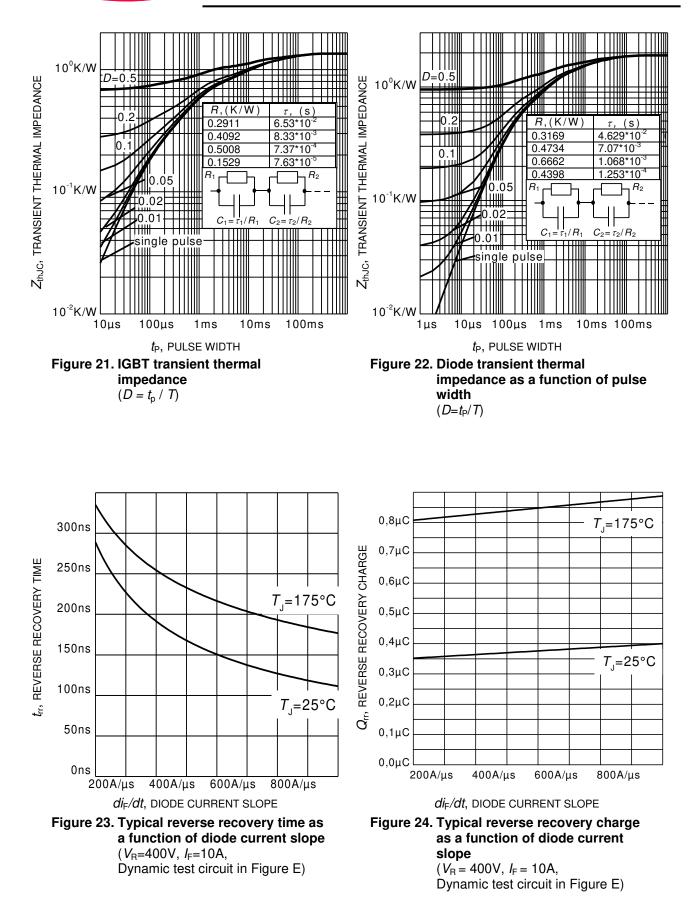




 V_{CE} , COLLECTOR-EMITTER VOLTAGE Figure 18. Typical capacitance as a function of collector-emitter voltage $(V_{GE}=0V, f = 1 \text{ MHz})$

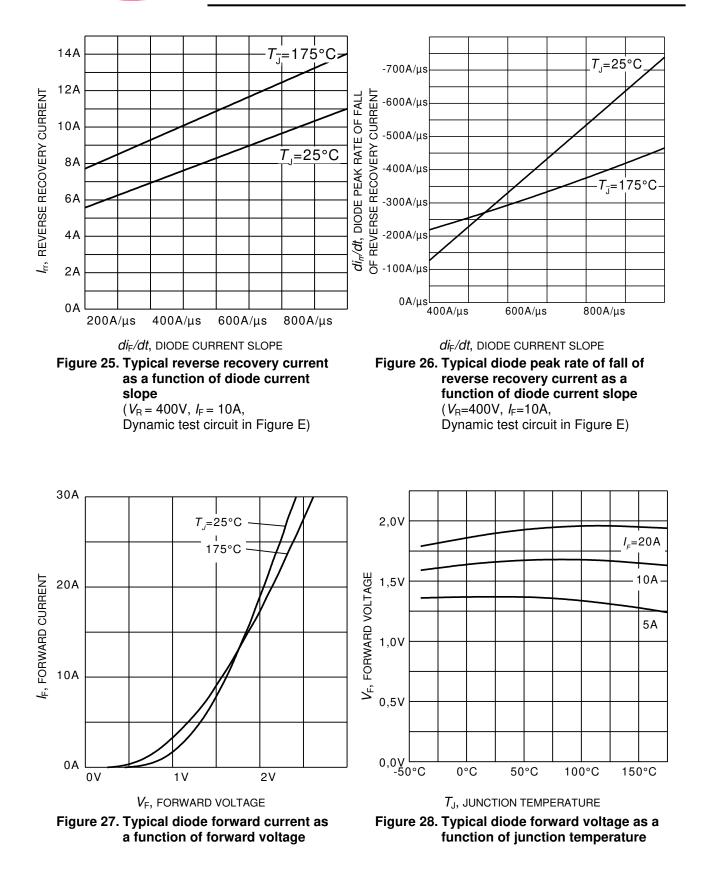








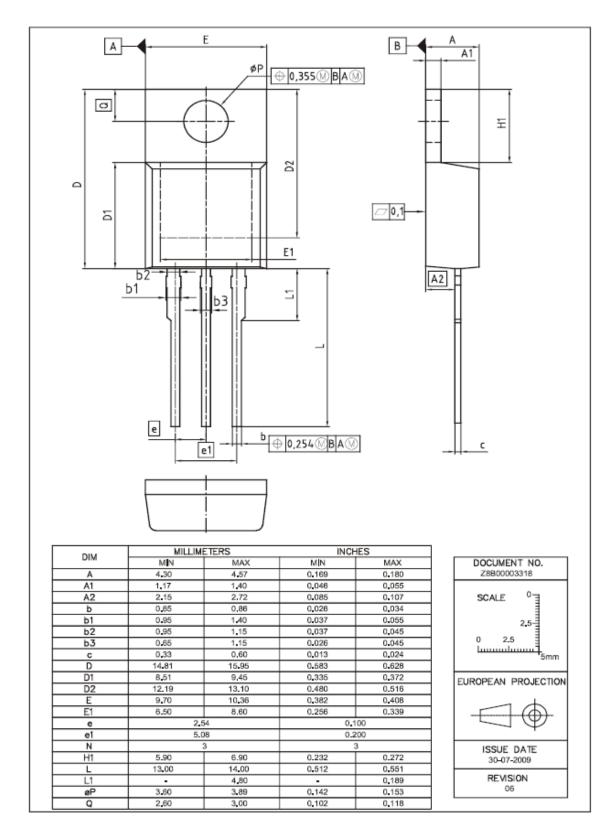




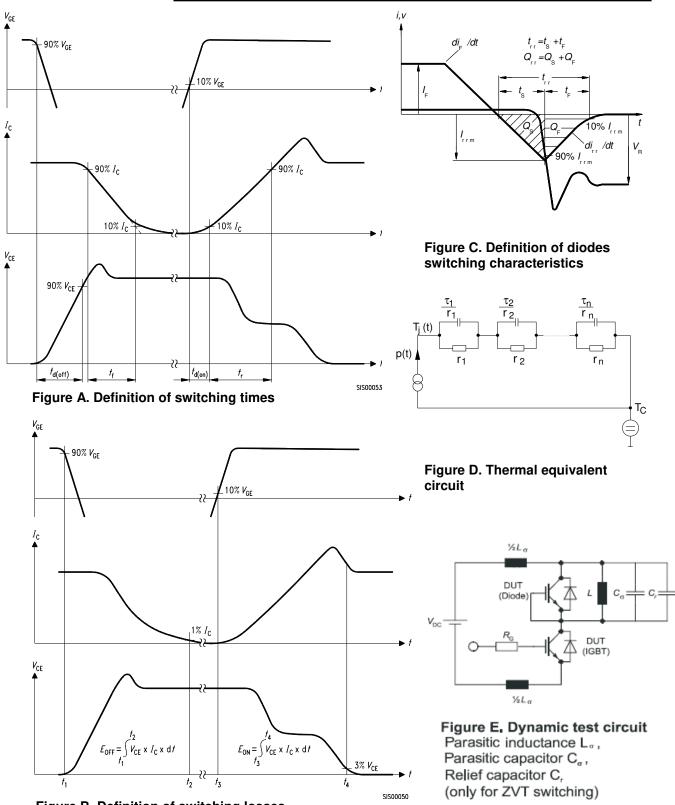


TRENCHSTOP™ Series

PG-TO220-3









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